



### MDP1603470RGE04 Information



For Reference Only

Part Number MDP1603470RGE04

Manufacturer Vishay Dale Category Resistors

Resistor Networks, Arrays

**Description** RES ARRAY 8 RES 470 OHM 16DIP

**Package** 16-DIP (0.300", 7.62mm)

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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## **MDP1603470RGE04 Specifications**

Manufacturer Part Number         MDP1603470RGE04           Manufacturer         Vishay Dale           Category         Resistors           Package         16-DIP (0.300", 7.62mm)           Series         MDP           Circuit Type         Isolated           Resistance (Ohms)         470           Tolerance         ±2%           Number of Resistors         8           Number of Pins         16           Power Per Element         250mW           Temperature Coefficient         ±100ppm/°C           Operating Temperature         -55°C ~ 125°C           Applications         -           Mounting Type         Through Hole           Package / Case         16-DIP (0.300", 7.62mm)           Supplier Device Package         16-DIP           Size / Dimension         0.850" L x 0.250" W (21.59mm x 6.35mm)           Height - Seated (Max)         0.155" (3.94mm)		
Category         Resistors           Resistor Networks, Arrays           Package         16-DIP (0.300", 7.62mm)           Series         MDP           Circuit Type         Isolated           Resistance (Ohms)         470           Tolerance         ±2%           Number of Resistors         8           Number of Pins         16           Power Per Element         250mW           Temperature Coefficient         ±100ppm/°C           Operating Temperature         -55°C ~ 125°C           Applications         -           Mounting Type         Through Hole           Package / Case         16-DIP (0.300", 7.62mm)           Supplier Device Package         16-DIP (0.300", 7.62mm)           Size / Dimension         0.850" L x 0.250" W (21.59mm x 6.35mm)           Height - Seated (Max)         0.155" (3.94mm)	Manufacturer Part Number	MDP1603470RGE04
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Circuit TypeIsolatedResistance (Ohms)470Tolerance±2%Number of Resistors8Number of Pins16Power Per Element250mWTemperature Coefficient±100ppm/°COperating Temperature-55°C ~ 125°CApplications-Mounting TypeThrough HolePackage / Case16-DIP (0.300", 7.62mm)Size / Dimension0.850" L x 0.250" W (21.59mm x 6.35mm)Height - Seated (Max)0.155" (3.94mm)	Package	16-DIP (0.300", 7.62mm)
Resistance (Ohms)       470         Tolerance       ±2%         Number of Resistors       8         Number of Pins       16         Power Per Element       250mW         Temperature Coefficient       ±100ppm/°C         Operating Temperature       -55°C ~ 125°C         Applications       -         Mounting Type       Through Hole         Package / Case       16-DIP (0.300", 7.62mm)         Supplier Device Package       16-DIP         Size / Dimension       0.850" L x 0.250" W (21.59mm x 6.35mm)         Height - Seated (Max)       0.155" (3.94mm)	Series	MDP
Tolerance       ±2%         Number of Resistors       8         Number of Pins       16         Power Per Element       250mW         Temperature Coefficient       ±100ppm/°C         Operating Temperature       -55°C ~ 125°C         Applications       -         Mounting Type       Through Hole         Package / Case       16-DIP (0.300", 7.62mm)         Supplier Device Package       16-DIP         Size / Dimension       0.850" L x 0.250" W (21.59mm x 6.35mm)         Height - Seated (Max)       0.155" (3.94mm)	Circuit Type	Isolated
Number of Resistors  Number of Pins  16  Power Per Element  250mW  Temperature Coefficient  4100ppm/°C  Operating Temperature  -55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  16-DIP (0.300", 7.62mm)  Supplier Device Package  16-DIP  Size / Dimension  0.850" L x 0.250" W (21.59mm x 6.35mm)  Height - Seated (Max)  0.155" (3.94mm)	Resistance (Ohms)	470
Number of Pins  16  Power Per Element  250mW  Temperature Coefficient  ±100ppm/°C  Operating Temperature  -55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  16-DIP (0.300", 7.62mm)  Supplier Device Package  16-DIP  Size / Dimension  0.850" L x 0.250" W (21.59mm x 6.35mm)  Height - Seated (Max)  0.155" (3.94mm)	Tolerance	±2%
Power Per Element  250mW  Temperature Coefficient  ±100ppm/°C  Operating Temperature  -55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  16-DIP (0.300", 7.62mm)  Supplier Device Package  16-DIP  Size / Dimension  0.850" L x 0.250" W (21.59mm x 6.35mm)  Height - Seated (Max)  0.155" (3.94mm)	Number of Resistors	8
Temperature Coefficient ±100ppm/°C  Operating Temperature -55°C ~ 125°C  Applications -  Mounting Type Through Hole  Package / Case 16-DIP (0.300", 7.62mm)  Supplier Device Package 16-DIP  Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm)  Height - Seated (Max) 0.155" (3.94mm)	Number of Pins	16
Operating Temperature  -55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  16-DIP (0.300", 7.62mm)  Supplier Device Package  16-DIP  Size / Dimension  0.850" L x 0.250" W (21.59mm x 6.35mm)  Height - Seated (Max)  0.155" (3.94mm)	Power Per Element	250mW
Applications - Mounting Type Through Hole  Package / Case 16-DIP (0.300", 7.62mm)  Supplier Device Package 16-DIP  Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm)  Height - Seated (Max) 0.155" (3.94mm)	Temperature Coefficient	±100ppm/°C
Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Operating Temperature	-55°C ~ 125°C
Package / Case       16-DIP (0.300", 7.62mm)         Supplier Device Package       16-DIP         Size / Dimension       0.850" L x 0.250" W (21.59mm x 6.35mm)         Height - Seated (Max)       0.155" (3.94mm)	Applications	-
Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Mounting Type	Through Hole
Size / Dimension       0.850" L x 0.250" W (21.59mm x 6.35mm)         Height - Seated (Max)       0.155" (3.94mm)	Package / Case	16-DIP (0.300", 7.62mm)
Height - Seated (Max) 0.155" (3.94mm)	Supplier Device Package	16-DIP
	Size / Dimension	0.850" L x 0.250" W (21.59mm x 6.35mm)
Report errors?	Height - Seated (Max)	0.155" (3.94mm)
		Report errors?

#### MDP1603470RGE04 Guarantees



#### **Quality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

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### MDP1603470RGE04 Shipping Methods













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